ANDREA COLAÇO

Senior Hardware Engineer | Google, Inc. | andreacolaco@google.com

EDUCATION

Massachusetts Institute of Technology (MIT), Cambridge, MA PhD in Media Arts and Sciences Thesis Title: Compact and Low-Power Computational 3D Sensors for Gest Advisors: Prof. Vivek Goyal, Chris Schmandt.	GPA 5.0/5.0 tural Input.	Sept 2010 - May 2014
Massachusetts Institute of Technology (MIT), Cambridge, MA Master of Science in Media Technology Thesis Title: An Auditory Environment for Co-presence in Television View Advisor: Prof. Chris Schmandt.	GPA 5.0/5.0 ing.	Sept 2008 – June 2010
Birla Institute of Technology and Science (BITS), Pilani, India Bachelor of Engineering (Hons.) Electrical and Electronics Top 2% of 900 candidates, class rank 6 out of 120. Thesis Title: Remote Validation of Signed Certificates. Advisor: Dr. Srinivasan Ramani, HP Labs.	GPA 9.57/10	Aug 2003 – June 2007

SELECT AWARDS & HONORS

 Goa fellows award (top 10/500 state-wide applicants). LG Electronics graduate fellowship (top 2/250 candidates). 	
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WORK EXPERIENCE

Google, Inc.

Software Engineer

- Inventor and core engineering contributor of low-power user input technology in 2 major upcoming products.
- Algorithm design for key user-facing features enabled in Google's consumer electronic products.

3dim Tech, Inc., Cambridge MA

Founder and CEO

- Invented and prototyped 3dim's low-power, low-cost 3D motion tracking system for mobile and wearable devices.
- Application and UI integration: designed optimal location, configuration of sensor + interface integration of tracking data.

MIT Media Lab, Cambridge MA

Research Assistant

- Designed, prototyped and demonstrated proof-of-concept gestural interfaces for head mounted displays, smart phones and tablets.
- Designed and conducted human-computer interaction evaluation studies to test feasibility of new user interfaces.
- Experience with rapid prototyping breadboard level circuit design; fabrication laser cutting, water-jet cutting.
- Mentored 5 undergraduate researchers at MIT.
- Co-founded and organized Design & Innovation annual workshops to promote hands-on learning among undergraduates.

HP Labs, Palo Alto, CA **Research Intern**

 Designed and implemented denoising algorithms for time-of-flight depth maps through local correction of flying pixels. • Noise modeling with global regularization for correcting shape distortions that arise from multi-path interference.

Texas Instruments, TI R&D Center, Dallas, TX **Research Intern**

· Implemented a low-complexity method to reconstruct 3D models of objects using stereo images from cell phones using a small number of input views.

Aug 2014-Present

Oct 2012-July 2014

Sept 2008-Mar 2014

June 2012-Aug 2012

June 2011-Aug 2011

General Electric Research, Bangalore, India Electrical Engineer, GE Energy

Designed and developed an automation tool to obtain 2D/ 3D model of the core end of a generator, and to automate the
electromagnetic finite element analysis.

HP Labs, Bangalore, India

Research Intern

- Modeled and designed features for a universal multi-functional access interface for information networks through AIOs (All-In-Ones) (patent issued).
- Remote Validation of Signed Certificates: Validation of documents over a GPRS network via cell phones using 2D barcodes.

SELECT PUBLICATIONS

- First-Photon Imaging, A Kirmani, D. Venkatraman, D. Shin, **A. Colaço**, F. Wong, J. Shapiro, V. Goyal, *Science*, Nov 2013.
- Mime: Compact, Low-Power 3D Gesture Sensing for Interaction with Head-Mounted Displays, **A. Colaço**, A. Kirmani, N. Gong, H. Yang, C. Schmandt, and V. Goyal, in *Proc. ACM Symp. on User Interfaces and Software Technology*, 2013.
- Compressive Depth Map Acquisition Using a Single Photon-Counting Detector: Parametric Signal Processing meets Sparsity, **A. Colaço**, A. Kirmani, G. Howland, J. Howell, and V. K. Goyal, in *Proc. IEEE CVPR* 2012.
- CoDAC: A Compressive Depth Acquisition Camera Framework, A. Kirmani, A. Colaço, F. N. C. Wong, and V. K. Goyal, to appear in *Proc. IEEE Int. Conf. Acoustics, Speech, and Signal Processing*, 2012.
- Exploiting Sparsity in Time-of-Flight Range Acquisition Using a Single Time-Resolved Sensor, A. Kirmani, A. Colaço, F. N. C. Wong, and V. K. Goyal, *Optics Express*, vol. 19, no. 22, pp. 21485-21507, October 2011.

SELECT PRESS COVERAGE

 BBC: Camera takes 3D photos in the dark 	2013
 Boston Business Journal: BBJ Focus: 13 Cool Startups to watch 	2013
 NewScientist: Gesture that smartphones can appreciate 	2013
Wall Street Journal: MIT Contest Winner 3dim Brings Gesture Control to Mobile Devices	2013
• Xconomy: Gesture Is the New Touch: A Report from the MIT \$100K Competition	2013
 Wired: Augmented Reality: MIT's Compressive Depth Acquisition Camera 	2013

PROGRAMMING SKILLS

• Software: Python, C, MATLAB, Java.

Aug 2007-May 2008

Jan 2007- Aug 2007